

MOSFET – Power, N-Channel, Dual EFCP

24 V, 5 A, 46.2 mΩ

EFC4626R

Features

- 2.5 V Drive
- Protection Diode In
- Common–Drain Type
- 2 kV ESD HBM
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Lithium-ion Battery Charging and Discharging Switch

Specifications

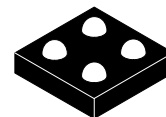
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter	Symbol	Conditions	Value	Unit
Source to Source Voltage	V_{SSS}		24	V
Gate to Source Voltage	V_{GSS}		± 10	V
Source Current (DC)	I_S		5	A
Source Current (Pulse)	I_{SP}	$PW \leq 10 \mu s$, duty cycle $\leq 1\%$	60	A
Total Dissipation	P_T	When mounted on ceramic substrate (5000 mm ² x 0.8 mm)	1.4	W
Junction Temperature	T_J		150	°C
Storage Temperature	T_{stg}		- 55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

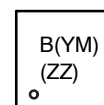
THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient When mounted on ceramic substrate (5000 mm ² x 0.8 mm)	R _{θJA}	84	V



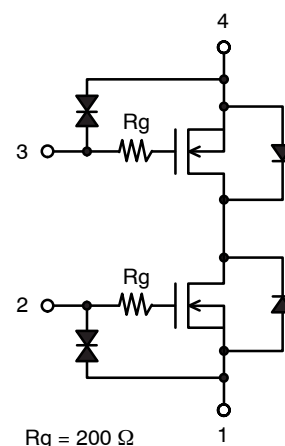
CSP4 1.01x1.01
CASE 568AK

MARKING DIAGRAM



B = Specific Device Code
Y = Year of Production
M = Assembly Operation Month
ZZ = Assembly Lot Number

ELECTRICAL CONNECTION



ORDERING INFORMATION

Device	Package	Shipping†
EFC4626R-TR	CSP4 (Pb-Free and Halogen Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Parameter	Symbol	Conditions		Min	Typ	Max	Unit
Source to Source Breakdown Voltage	$V_{(BR)SSS}$	$I_S = 1\text{ mA}$, $V_{GS} = 0\text{ V}$	Test Circuit 1	24	–	–	V
Zero–Gate Voltage Source Current	I_{SSS}	$V_{SS} = 20\text{ V}$, $V_{GS} = 0\text{ V}$	Test Circuit 1	–	–	1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 8\text{ V}$, $V_{SS} = 0\text{ V}$	Test Circuit 2	–	–	± 1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{SS} = 10\text{ V}$, $I_S = 1\text{ mA}$	Test Circuit 3	0.5	–	1.3	V
Forward Transconductance	g_{FS}	$V_{SS} = 10\text{ V}$, $I_S = 2\text{ A}$	Test Circuit 4	–	7	–	S
Static Source to Source On–State Resistance	$R_{SS(on)1}$	$I_S = 2\text{ A}$, $V_{GS} = 4.5\text{ V}$	Test Circuit 5	29.2	37.5	46.2	$\text{m}\Omega$
	$R_{SS(on)2}$	$I_S = 2\text{ A}$, $V_{GS} = 4.0\text{ V}$	Test Circuit 5	30.8	39.5	48.6	$\text{m}\Omega$
	$R_{SS(on)3}$	$I_S = 2\text{ A}$, $V_{GS} = 3.8\text{ V}$	Test Circuit 5	32.0	41.0	50.5	$\text{m}\Omega$
	$R_{SS(on)4}$	$I_S = 2\text{ A}$, $V_{GS} = 3.1\text{ V}$	Test Circuit 5	35.5	45.5	58.3	$\text{m}\Omega$
	$R_{SS(on)5}$	$I_S = 2\text{ A}$, $V_{GS} = 2.5\text{ V}$	Test Circuit 5	42.6	54.0	72.4	$\text{m}\Omega$
Turn–On Delay Time	$t_d(on)$	$V_{SS} = 10\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_S = 2\text{ A}$	Test Circuit 6	–	20	–	ns
Rise Time	t_r			–	350	–	ns
Turn–Off Delay Time	$t_d(off)$			–	22000	–	ns
Fall Time	t_f			–	38400	–	ns
Total Gate Charge	Q_g	$V_{SS} = 10\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_S = 5\text{ A}$	Test Circuit 7	–	7.5	–	nC
Forward Source to Source Voltage	$V_{F(S-S)}$	$I_S = 2\text{ A}$, $V_{GS} = 0\text{ V}$	Test Circuit 8	–	0.81	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test Circuits are Example of Measuring FET1 Side.

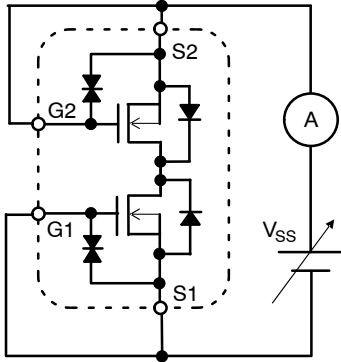


Figure 1. Test Circuit 1 – I_{SSS}

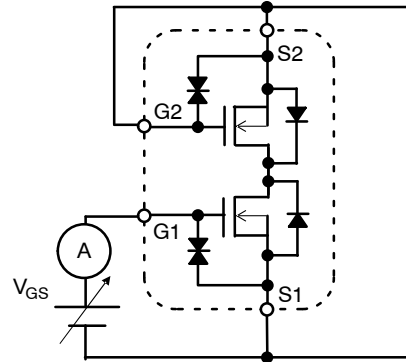


Figure 2. Test Circuit 2 – I_{GSS}

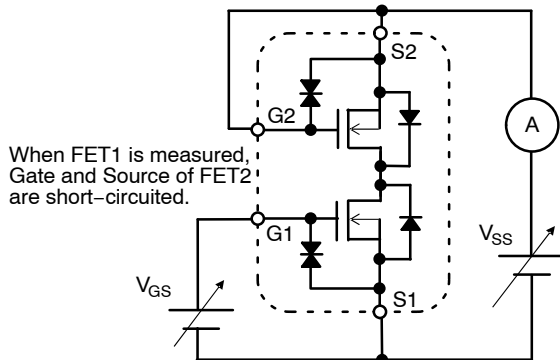


Figure 3. Test Circuit 3 – $V_{GS(th)}$

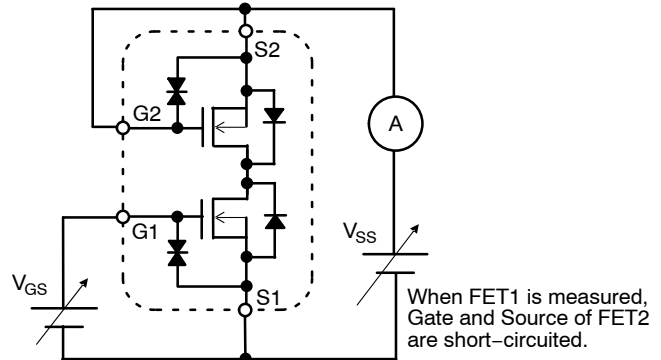
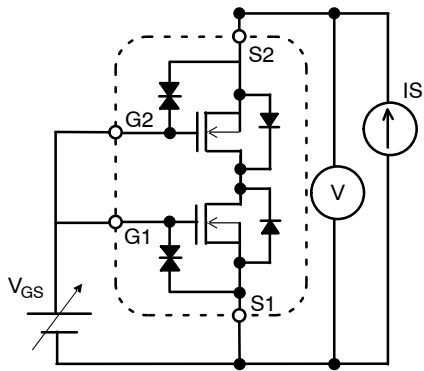
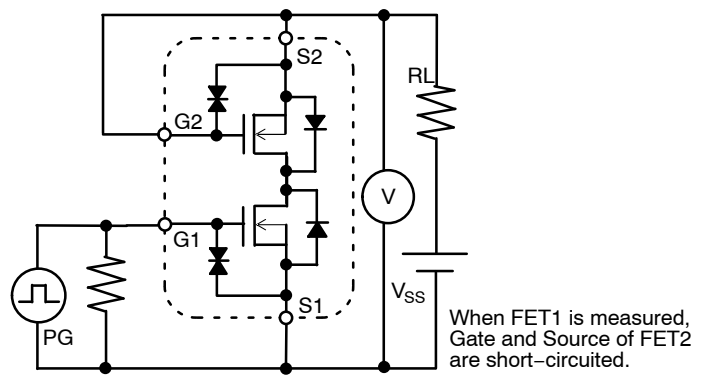
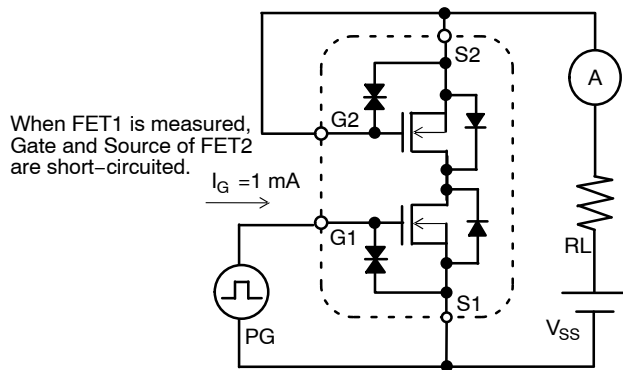
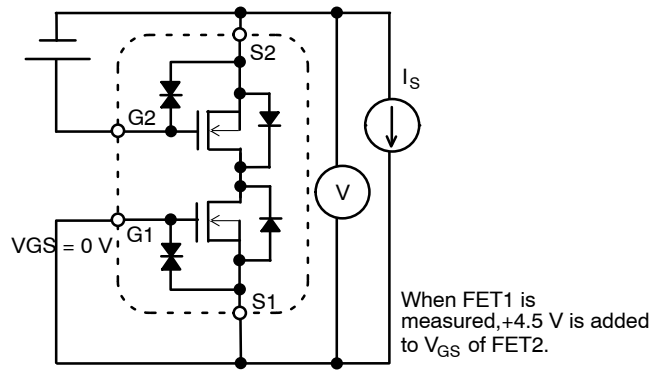


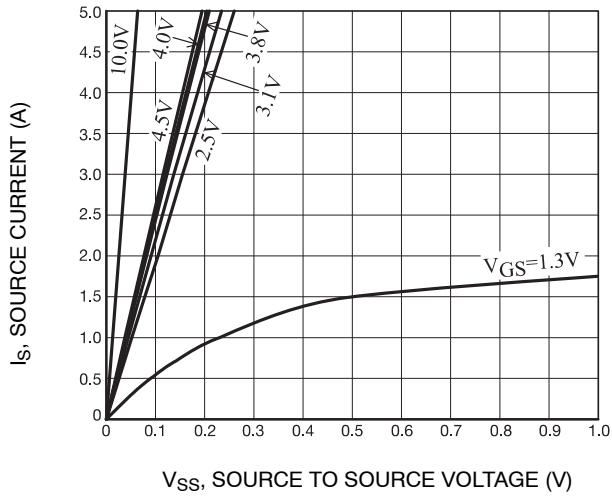
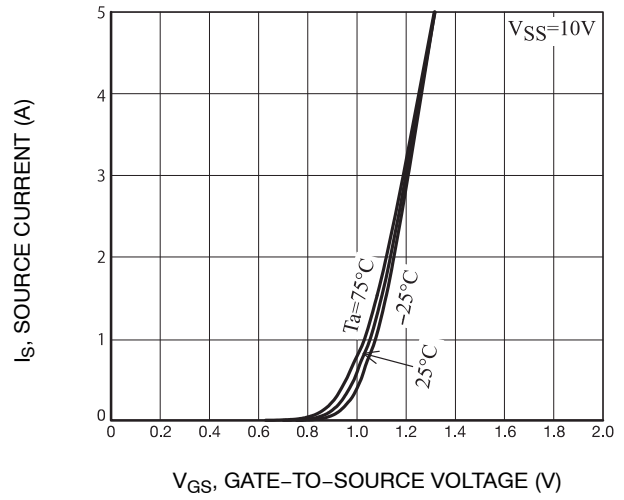
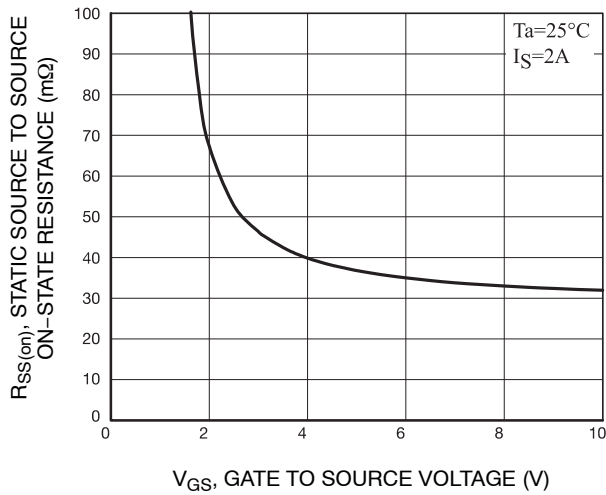
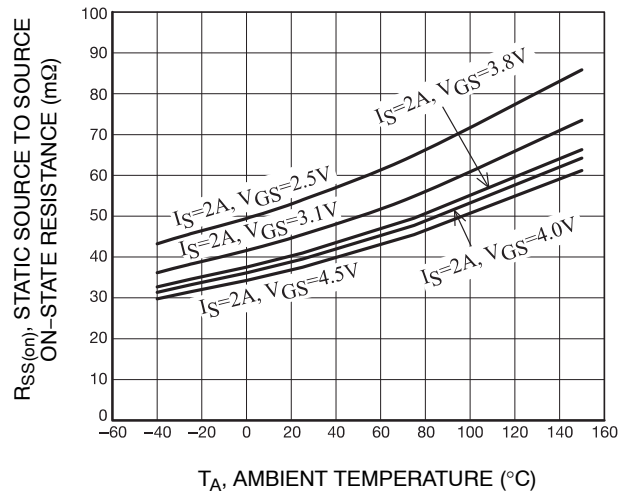
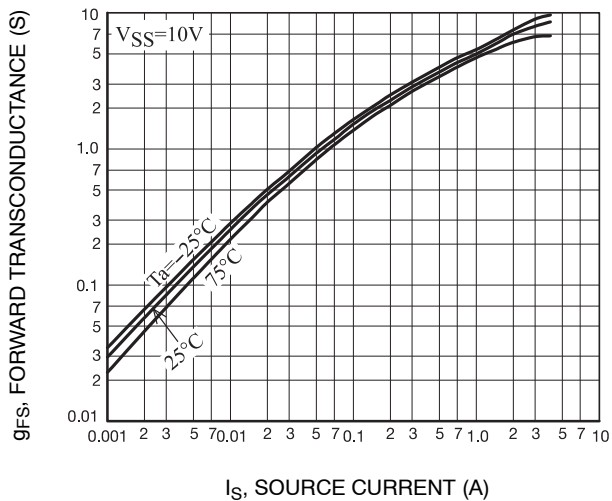
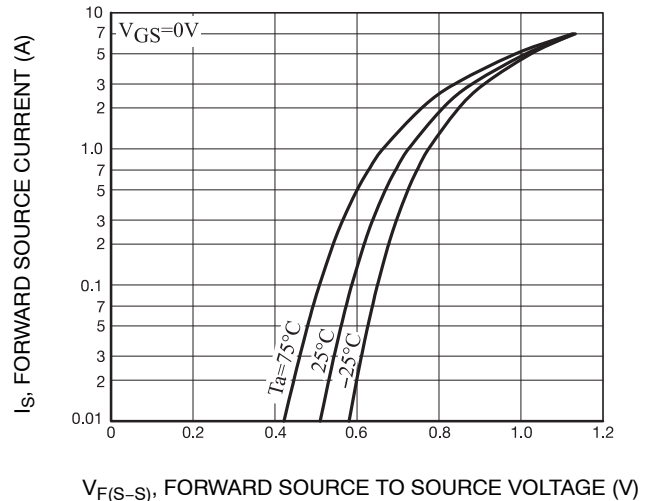
Figure 4. Test Circuit 4 – g_{FS}

TEST CIRCUITS (continued)

Figure 5. Test Circuit 5 – $R_{SS(on)}$ Figure 6. Test Circuit 6 – $t_d(on)$, t_r , $t_d(off)$, t_f Figure 7. Test Circuit 7 – Q_g Figure 8. Test Circuit 8 – $V_{F(S-S)}$

NOTE: When FET2 is measured, the position of FET1 and FET2 is switched.

TYPICAL CHARACTERISTICS

Figure 9. $I_S - V_{SS}$ Figure 10. $I_S - V_{GS}(th)$ Figure 11. $R_{SS(on)} - V_{GS}$ Figure 12. $R_{SS(on)} - T_A$ Figure 13. $g_{FS} - I_S$ Figure 14. $I_S - V_{F(S-S)}$

TYPICAL CHARACTERISTICS (continued)

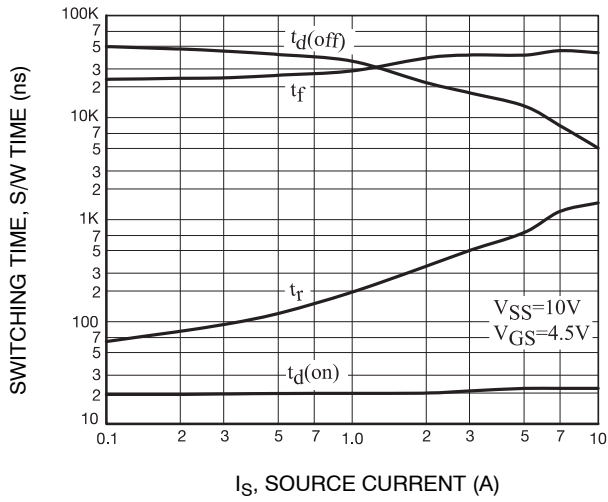
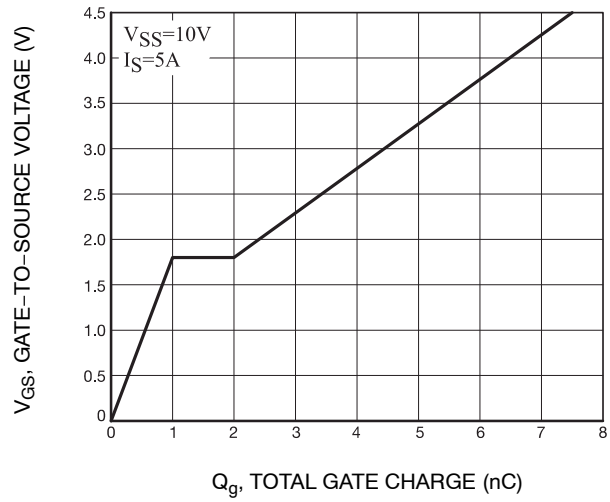
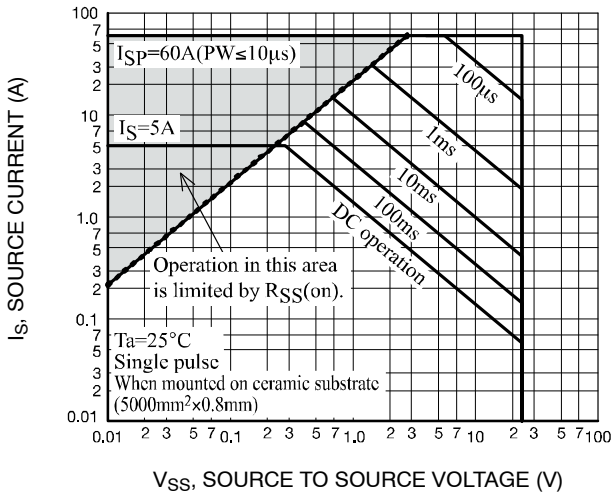
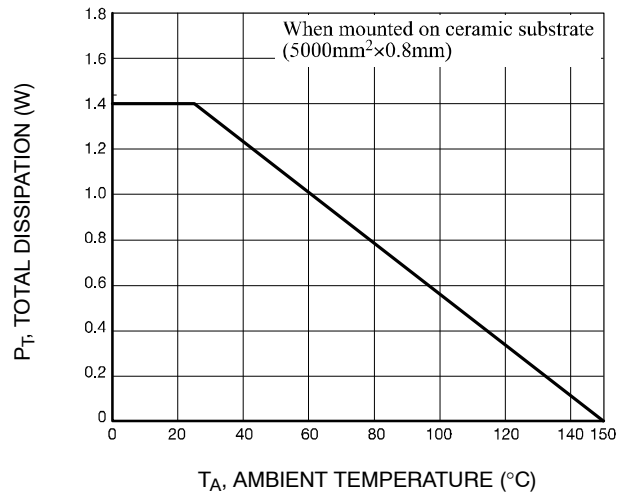
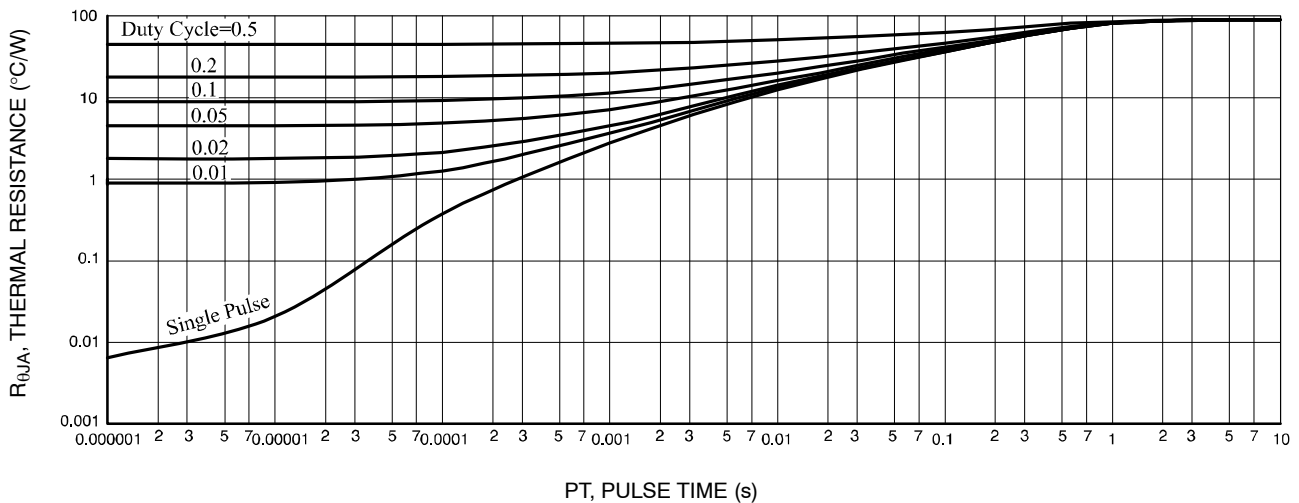
Figure 15. S/W Time – I_S Figure 16. V_{GS} – Q_g 

Figure 17. SOA

Figure 18. P_T – T_A Figure 19. $R_{\theta JA}$ – Pulse Time

EFC4626R

PACKAGE DIMENSION

EFC4626R-TR

(Unit: mm)

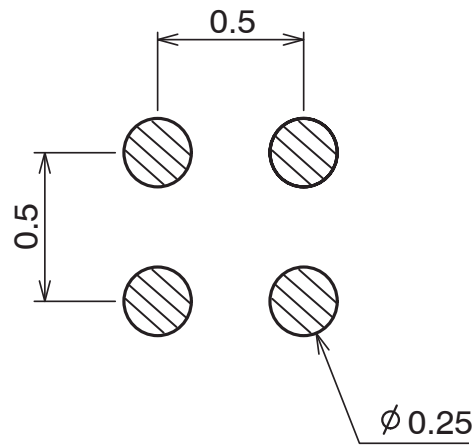
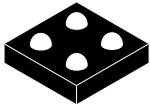


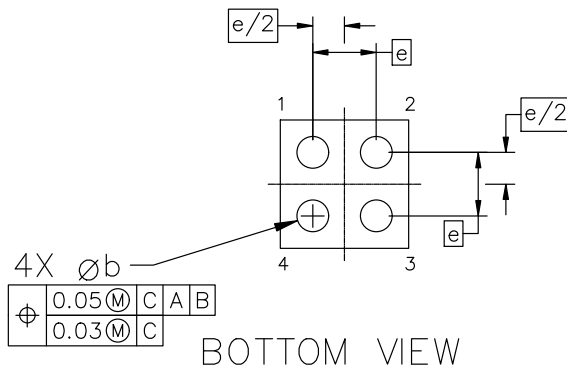
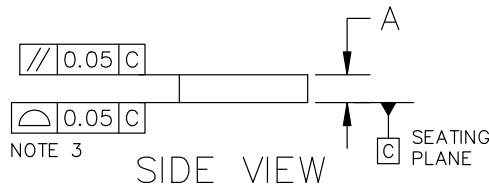
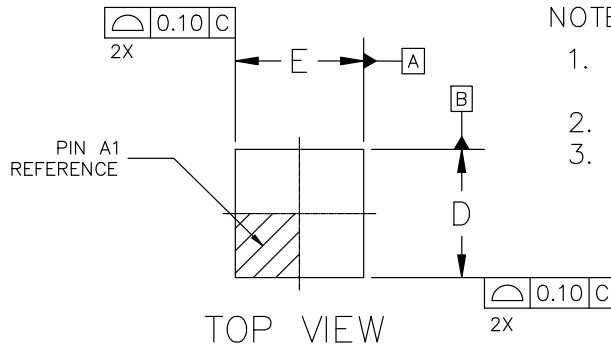
Figure 20. Recommended Soldering Footprint

Note on usage: Since the EFC4626R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.



WLCSP4, 1.01x1.01x0.20, 0.50P
CASE 568AK
ISSUE C

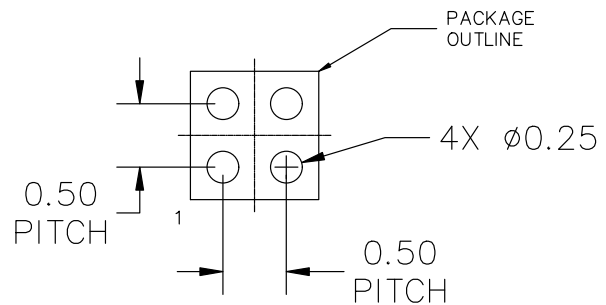
DATE 05 NOV 2024



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.18	0.20	0.22
b	0.22	0.25	0.28
D	0.99	1.01	1.11
E	0.99	1.01	1.11
e	0.50 BSC		



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques References manual, SOLDERM/D.

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DESCRIPTION:	WLCSP4, 1.01x1.01x0.20, 0.50P	PAGE 1 OF 1

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